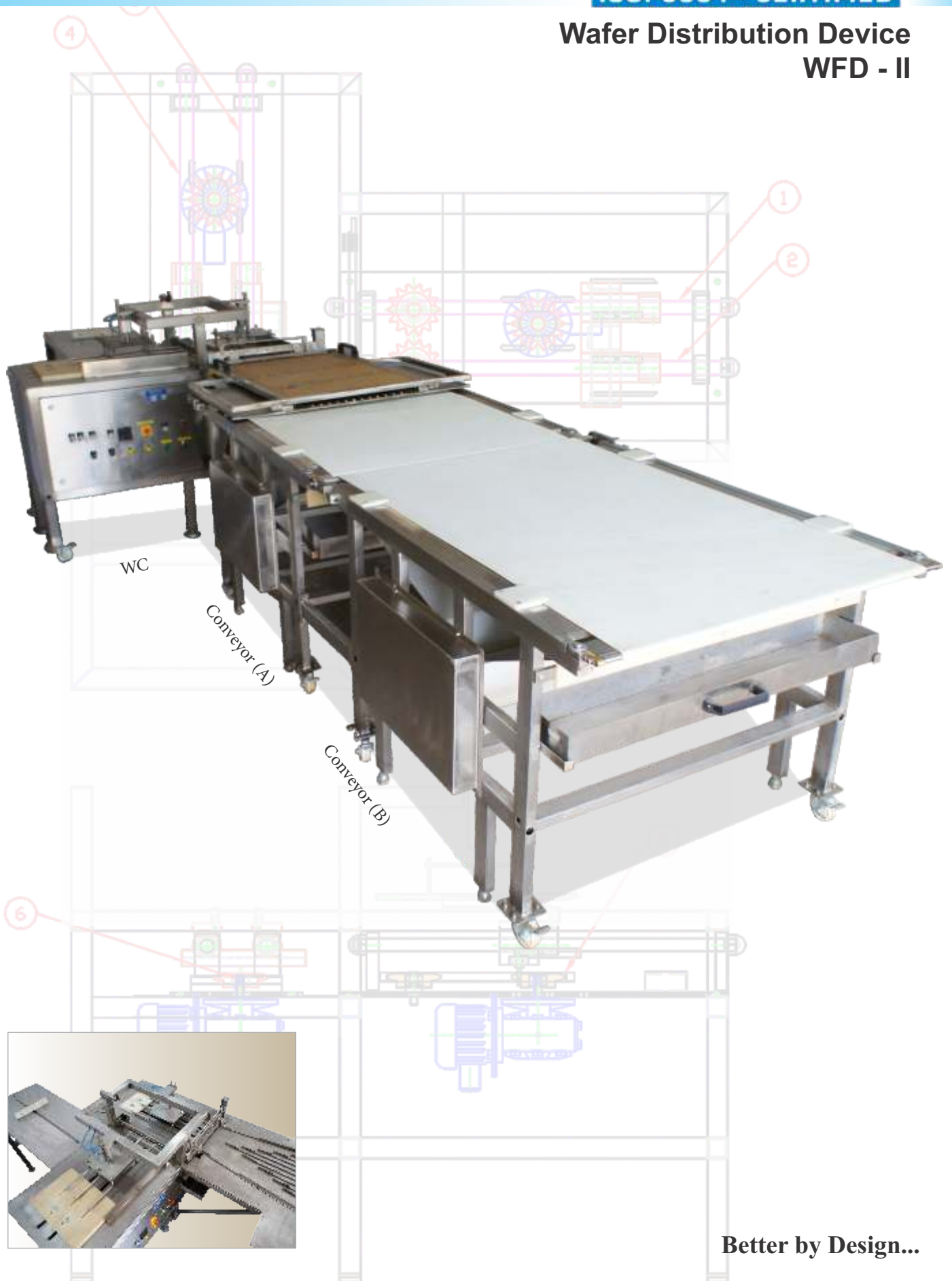




ISO: 9001 - CERTIFIED

Wafer Distribution Device WFD - II



Better by Design...

Wafer Distribution (WFD) - Type II

This is a compact version of wafer cutting and mini distribution.

The cut wafer biscuit move directly and immediately from the cutting machine on to a conveyor with limited distribution.

Once the wafer biscuits are separated side to side, the conveyor carries the spread wafer biscuit forward on to chocolate coating line.

Conveyor (A) - Horizontal separation by guides.

Conveyor (B) - Vertical separation by inventor controlled belt speed.

The WFD - II

Consists of standard machines

- 1) Conveyor (A) & (B)
- 2) WC - Wafer Cutting Machine

Optional Accessories

- 1) Exchange distribution tables with divider guides suitable to cut size can be ordered separately for our

WFD II Machine



Technical Details*

Wafer Cutting & Distributor	WFD 2
Size of the Wafers (Possible)	290 x 460**
Capacity / Book per min.	6
Minimum Cutting Width (mm)	25
Cutting Wire (Spring Steel in mm)	0.5
Connected load (KW)	2.0

Dimension (mm)	Conveyor A	Conveyor B	WC	Total
Length	1500	1500	1700	
Width	1200	1200	1600	
Height	1000	1000	1200	
Belt Width	1000 m	1000 m	X	
Net Weight (appx. kgs)	125	125	310	560
Shipping Volume (CBM)	2.0	2.0	4.5	8.5



Wafer Cutting sizes chart
Scan QR code

*Modifications Reserved **Other Sizes on request

We are constantly guided by our principle of offering our customers better and better machines; to give increased efficiency and higher levels of automation. The technical data and illustrations are subject to change without notice

R & D Engineers

A-41, IDA Kukatpally, Phase II, Road No. 4,
Via I.E. Gandhi Nagar, Hyderabad - 500 037. India
Phone : +91 040 23402682
Mobile : +91 9959000380
Email : info@rndwafers.com

Local Contact :

Web : www.rndwafers.com